

RUF025N02

Nch 20V 2.5A Power MOSFET

V_{DSS}	20V
R _{DS(on)} (Max.)	54m Ω
I _D	2.5A
P_D	0.8W

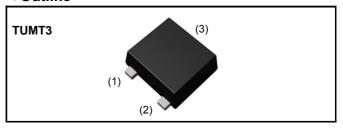
Features

- 1) Low on resistance.
- 2) 1.5V Drive.
- 3) Built-in G-S Protection Diode.
- 4) Small Surface Mount Package (TUMT3).
- 5) Pb-free lead plating; RoHS compliant

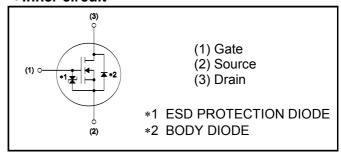
Application

DC/DC converters

Outline



•Inner circuit



Packaging specifications

		
	Packaging	Taping
Туре	Reel size (mm)	180
	Tape width (mm)	8
	Basic ordering unit (pcs)	3,000
	Taping code	TL
	Marking	XE

● Absolute maximum ratings(T_a = 25°C)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V_{DSS}	20	V
Continuous drain current	I _D *1	±2.5	А
Pulsed drain current	I _{D,pulse} *2	±5	А
Gate - Source voltage	V_{GSS}	±10	V
Power dissipation	P _D *3	0.8	W
Power dissipation	P _D *4	0.32	W
Junction temperature	T _j	150	°C
Range of storage temperature	T _{stg}	-55 to +150	°C

●Thermal resistance

Parameter	Symbol	Values			Unit
- Faranietei		Min.	Тур.	Max.	Offic
Thermal resistance, junction - ambient	R _{thJA} *3	-	-	156	°C/W
	R _{thJA} *4	-	-	391	°C/W

•Electrical characteristics($T_a = 25^{\circ}C$)

Parameter	Symbol	Conditions	Values			Unit
- Farameter	Syllibol	Conditions	Min.	Тур.	Max.	Offic
Drain - Source breakdown voltage	V _{(BR)DSS}	$V_{GS} = 0V$, $I_D = 1mA$	20	1	1	V
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{j}}$	I _D =1mA referenced to 25°C	-	20	-	mV/°C
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 20V, V_{GS} = 0V$	-	-	1	μА
Gate - Source leakage current	I _{GSS}	$V_{GS} = \pm 10V, V_{DS} = 0V$	-	-	±10	μА
Gate threshold voltage	V _{GS (th)}	V_{DS} = 10V, I_D = 1mA	0.3	-	1.3	V
Gate threshold voltage temperature coefficient	$\frac{\Delta V_{(GS)th}}{\Delta T_{j}}$	I _D =1mA referenced to 25°C	-	-1.9	-	mV/°C
		V _{GS} =4.5V, I _D =2.5A	-	39	54	
	R _{DS(on)} *5	V _{GS} =2.5V, I _D =2.5A	-	49	68	
Static drain - source on - state resistance		V _{GS} =1.8V, I _D =1.3A	ı	65	91	mΩ
		V _{GS} =1.5V, I _D =0.5A	ı	80	160	
		V _{GS} =4.5V, I _D =2.5A, T _j =125°C	-	65	95	
Gate input resistannce	R_G	f = 1MHz, open drain	-	7.5	-	Ω
Transconductance	9 fs *5	V _{DS} =10V, I _D =2.5A	3.6	6.0	-	S

^{*1} Limited only by maximum temperature allowed.

^{*2} Pw \leq 10 $\mu s,~Duty~cycle \leq$ 1%

^{*3} Mounted on a seramic board (30×30×0.8mm)

^{*4} Mounted on a FR4 (15×20×0.8mm)

^{*5} Pulsed

•Electrical characteristics($T_a = 25^{\circ}C$)

Parameter	Symbol	Conditions	Values			Unit
- Farameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Input capacitance	C _{iss}	V _{GS} = 0V	-	370	-	
Output capacitance	C _{oss}	V _{DS} = 10V	-	90	-	pF
Reverse transfer capacitance	C_{rss}	f = 1MHz	-	50	-	
Turn - on delay time	t _{d(on)} *5	$V_{DD} \simeq 10V$, $V_{GS} = 4.5V$	-	7	-	
Rise time	t _r *5	I _D = 1.3A	-	15	-	no
Turn - off delay time	t _{d(off)} *5	$R_L = 7.7\Omega$	-	35	-	ns
Fall time	t _f *5	$R_G = 10\Omega$	-	15	-	

•Gate Charge characteristics($T_a = 25$ °C)

Parameter	Symbol Conditions	Conditions	Values			Unit
		Min.	Тур.	Max.	Offic	
Total gate charge	Q_g^{*5}		-	5	-	
Gate - Source charge	Q _{gs} *5	$V_{DD} \simeq 10V$, $I_D=2.5A$ $V_{GS} = 4.5V$	-	0.9	-	nC
Gate - Drain charge	Q _{gd} *5	- 55	-	0.8	-	

●Body diode electrical characteristics (Source-Drain)(T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
r arameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Inverse diode continuous, forward current	l _S *1	T _a = 25°C	-	-	0.6	А
Forward voltage	V _{SD} *5	$V_{GS} = 0V, I_s = 0.6A$	-	-	1.2	V

Fig.1 Power Dissipation Derating Curve

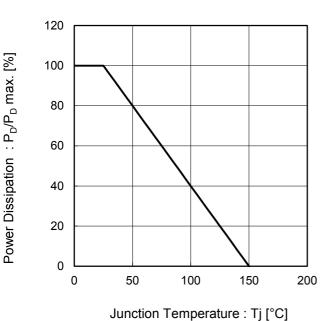
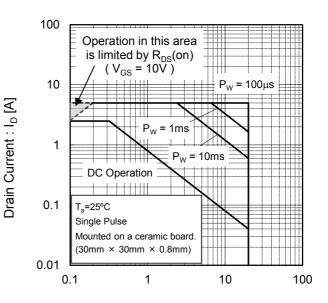
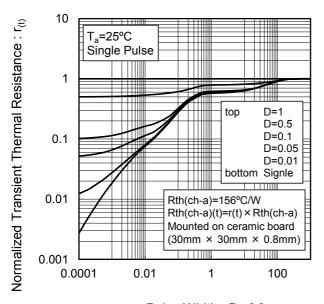


Fig.2 Maximum Safe Operating Area



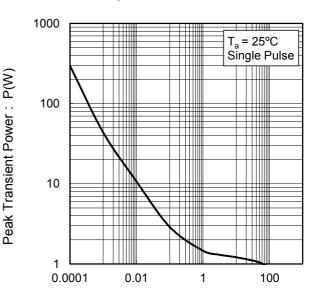
Drain - Source Voltage : V_{DS} [V]

Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width



Pulse Width: Pw [s]

Fig.4 Single Pulse Maxmum Power dissipation



Pulse Width : P_W [s]

Drain Current : I_D [A]

•Electrical characteristic curves

Fig.5 Typical Output Characteristics(I)

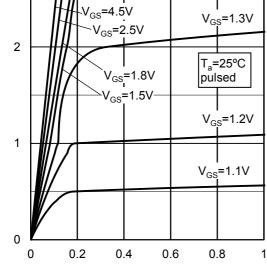
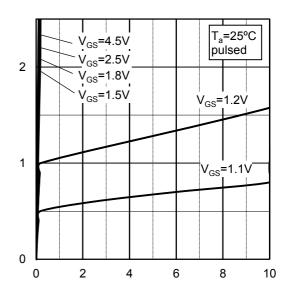


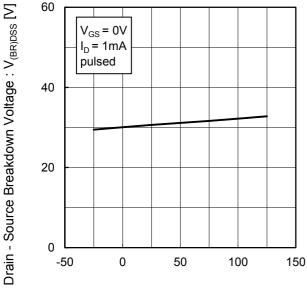
Fig.6 Typical Output Characteristics(II)



Drain - Source Voltage : V_{DS} [V]

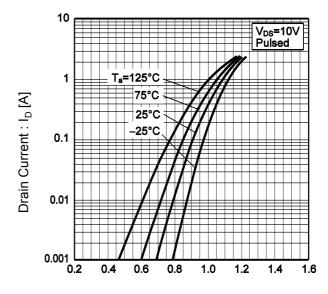
Drain - Source Voltage : V_{DS} [V]

Fig.7 Breakdown Voltage vs. Junction Temperature



Junction Temperature : T_j [°C]

Fig.8 Typical Transfer Characteristics

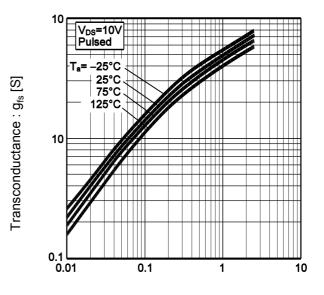


Gate - Source Voltage : V_{GS} [V]

Drain Current : I_D [A]

Fig.9 Gate Threshold Voltage vs. Junction Temperature 3 $V_{DS} = 10V$ $I_D = 1mA$ Gate Threshold Voltage: V_{GS(th)} [V] pulsed 2 -50 0 50 100 150 Junction Temperature : T_i [°C]

Fig.10 Transconductance vs. Drain Current



Drain Current : I_D [A]

T_a=25°C

Pulsed

Fig.11 Drain CurrentDerating Curve

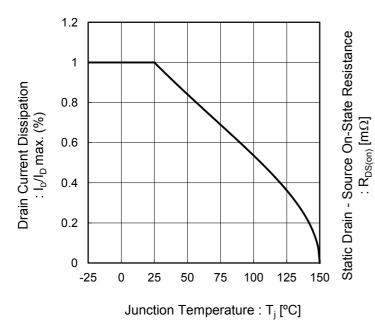


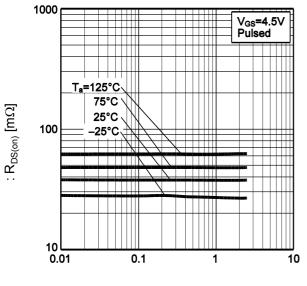
Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage 100 80 I_D=2.5A 60 I_D=1.3A 40 20

Gate - Source Voltage : V_{GS} [V]

Static Drain - Source On-State Resistance

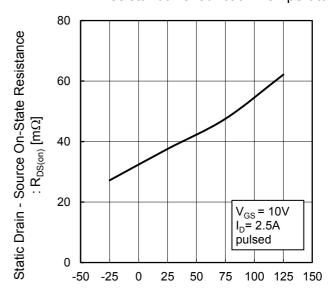
•Electrical characteristic curves

Fig.13 Static Drain - Source On - State Resistance vs. Drain Current(I)



Drain Current : I_D [A]

Fig.14 Static Drain - Source On - State Resistance vs. Junction Temperature



Junction Temperature : T_j [°C]

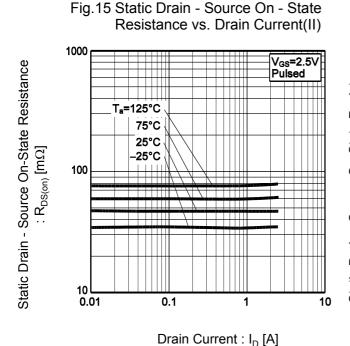


Fig.16 Static Drain-Source On-State
Resistance vs. Drain Current(III)

1000

T_a=125°C

75°C

-25°C

-25°C

-25°C

100

0.01

0.1

1 1

Drain Current : In [A]

Fig.17 Static Drain - Source On - State
Resistance vs. Drain Current(IVI)

1000

T_a=125°C

75°C

25°C

-25°C

-25°C

100

Drain Current : I_D [A]

Resistance vs. Drain Current(V)

1000

Vas=1.5V

Vas=1.5V

Vas=2.5V

Vas=4.5V

Vas=4.5V

Drain Current: I_D [A]

Fig.18 Static Drain - Source On - State

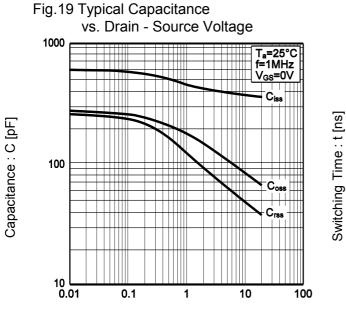
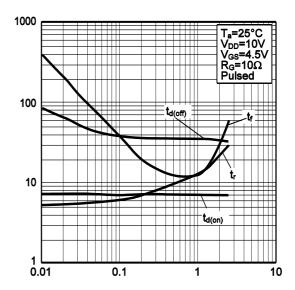


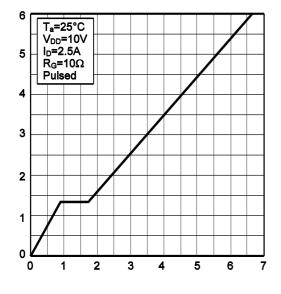
Fig.20 Switching Characteristics



Drain - Source Voltage : V_{DS} [V]

Drain Current: I_D [A]

Fig.21 Dynamic Input Characteristics



Total Gate Charge : Q_q [nC]

Source Current : I_s [A]

vs. Source Drain Voltage

T_a=125°C

75°C

25°C

-25°C

0.01

0.01

0.01

1.5

Fig.22 Source Current

Source-Drain Voltage : V_{SD} [V]

●Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

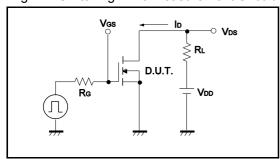


Fig.2-1 Gate Charge Measurement Circuit

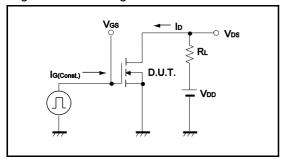


Fig.1-2 Switching Waveforms

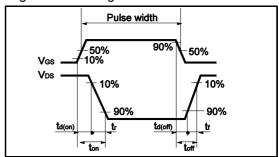
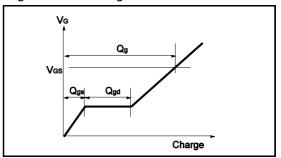
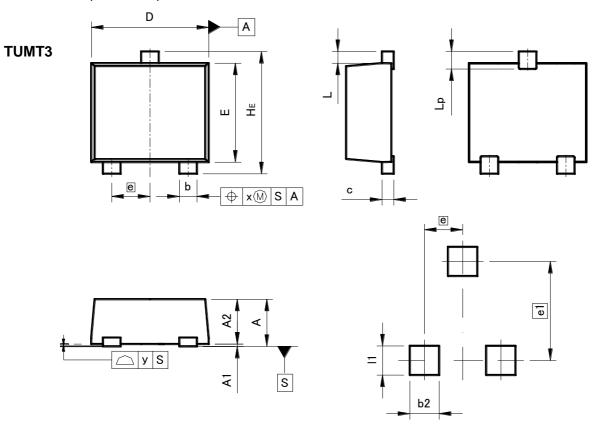


Fig.2-2 Gate Charge Waveform



●Dimensions (Unit: mm)



Patterm of terminal position areas

DIM	DIM MILIMETERS			HES
DIIVI	MIN	MAX	MIN	MAX
Α	I	0.85	I	0.033
A1	0.00	0.10	0	0.004
A2	0.72	0.82	0.028	0.032
b	0.25	0.40	0.01	0.016
С	0.12	0.22	0.005	0.009
D	1.90	2.10	0.075	0.083
E	1.60	1.80	0.063	0.071
е	0.0	65	0.0	03
HE	2.00	2.20	0.079	0.087
L	0.20		0.0	01
Lp	- 1	0.40	- 1	0.016
х	- 1	0.10	- 1	0.004
У	_	0.10	_	0.004

DIM MILIME		MILIMETERS INC		HES
MIN		MAX	MIN	MAX
e1	1.	1.70		67
b2	ı	- 0.50		0.02
11	_	0.50	-	0.02

Dimension in mm/inches

Notes

- 1) The information contained herein is subject to change without notice.
- Before you use our Products, please contact our sales representative and verify the latest specifications:
- 3) Although ROHM is continuously working to improve product reliability and quality, semiconductors can break down and malfunction due to various factors. Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM
- 4) Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.
- 5) The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.
- 6) The Products are intended for use in general electronic equipment (i.e. AV/OA devices, communication, consumer systems, gaming/entertainment sets) as well as the applications indicated in this document.
- 7) The Products specified in this document are not designed to be radiation tolerant.
- 8) For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative: transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, servers, solar cells, and power transmission systems.
- 9) Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.
- 10) ROHM shall have no responsibility for any damages or injury arising from non-compliance with the recommended usage conditions and specifications contained herein.
- 11) ROHM has used reasonable care to ensur the accuracy of the information contained in this document. However, ROHM does not warrants that such information is error-free, and ROHM shall have no responsibility for any damages arising from any inaccuracy or misprint of such information.
- 12) Please use the Products in accordance with any applicable environmental laws and regulations, such as the RoHS Directive. For more details, including RoHS compatibility, please contact a ROHM sales office. ROHM shall have no responsibility for any damages or losses resulting non-compliance with any applicable laws or regulations.
- 13) When providing our Products and technologies contained in this document to other countries, you must abide by the procedures and provisions stipulated in all applicable export laws and regulations, including without limitation the US Export Administration Regulations and the Foreign Exchange and Foreign Trade Act.
- 14) This document, in part or in whole, may not be reprinted or reproduced without prior consent of ROHM.



Thank you for your accessing to ROHM product informations. More detail product informations and catalogs are available, please contact us.

ROHM Customer Support System

http://www.rohm.com/contact/